P-Channel 2.5-V (G-S) MOSFET

PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
- 25	0.180 at V_{GS} = - 4.5 V	± 1.5
	0.200 at V_{GS} = - 3.6 V	± 1.4
	0.265 at V_{GS} = - 2.5 V	± 1.2

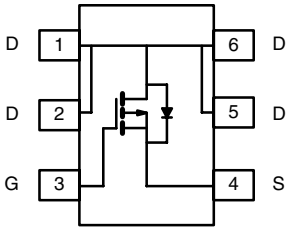
FEATURES

- TrenchFET® Power MOSFET

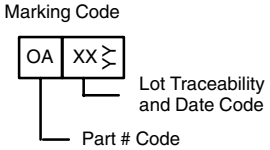
Pb-free Available

RoHS* COMPLIANT

SOT-363
SC-70 (6-LEADS)



Top View



Ordering Information: Si1403DL-T1
Si1403DL-T1-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted					
Parameter		**Symbol**	**5 Sec**	**Steady State**	**Unit**
Drain-Source Voltage		V_{DS}	- 20		V
Gate-Source Voltage		V_{GS}	± 12		
Continuous Drain Current (T_J = 150 °C)	T_A = 25 °C	I_D	± 1.5	± 1.4	A
	T_A = 85 °C		± 1.2	± 1.0	
Pulsed Drain Current		I_{DM}	± 5		
Continuous Diode Current (Diode Conduction)[a]		I_S	- 0.8	- 0.8	
Maximum Power Dissipation[a]	T_A = 25 °C	P_D	0.625	0.568	W
	T_A = 85 °C		0.400	0.295	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		**Symbol**	**Typical**	**Maximum**	**Unit**
Maximum Junction-to-Ambient[a]	t ≤ 5 sec	R_{thJA}	165	200	°C/W
	Steady State		180	220	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	105	130	

Notes:
a. Surface mounted on 1" x 1" FR4 board.

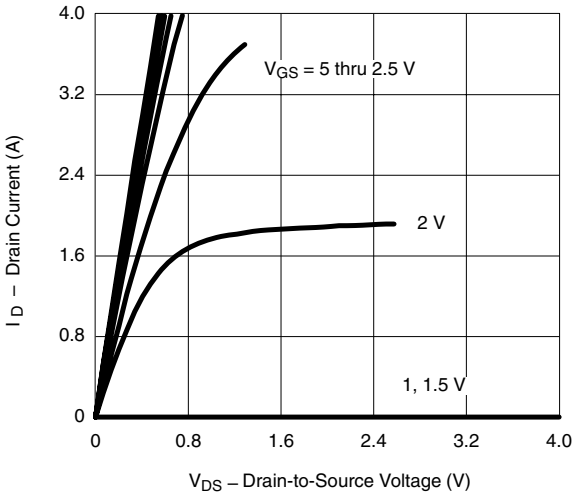
* Pb containing terminations are not RoHS compliant, exemptions may apply.

SPECIFICATIONS T_J = 25 °C, unless otherwise noted						
Parameter	**Symbol**	**Test Condition**	**Min**	**Typ**	**Max**	**Unit**
Static						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = - 250 µA	- 0.6		- 1.5	V
Gate-Body Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 12 V			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = - 20 V, V_{GS} = 0 V			- 1	µA
		V_{DS} = - 20 V, V_{GS} = 0 V, T_J = 85 °C			- 5	
On-State Drain Current[a]	$I_{D(on)}$	V_{DS} = - 5 V, V_{GS} = - 4.5 V	- 2			A
Drain-Source On-State Resistance[a]	$r_{DS(on)}$	V_{GS} = - 4.5 V, I_D = - 1.5 A		0.145	0.180	Ω
		V_{GS} = - 3.6 V, I_D = - 1.4 A		0.165	0.200	
		V_{GS} = - 2.5 V, I_D = - 0.8 A		0.220	0.265	
Forward Transconductance[a]	g_{fs}	V_{GS} = - 10 V, I_D = - 1.5 A		3.8		S
Diode Forward Voltage[a]	V_{SD}	I_S = - 0.8, V_{GS} = 0 V		- 0.78	- 1.1	V
Dynamic[b]						
Total Gate Charge	Q_g	V_{DS} = - 10 V, V_{GS} = - 4.5 V, I_D = - 1.5 A		3.7	4.5	nC
Gate-Source Charge	Q_{gs}			0.9		
Gate-Drain Charge	Q_{gd}			0.9		
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = -10 V, R_L = 10 Ω $I_D \cong$ - 1 A, V_{GEN} = - 4.5 V, R_G = 6 Ω		8	12	ns
Rise Time	t_r			25	40	
Turn-Off DelayTime	$t_{d(off)}$			21	32	
Fall Time	t_f			20	30	
Source-Drain Reverse Recovery Time	t_{rr}	I_F = - 0.8 A, di/dt = 100 A/µs		20	40	

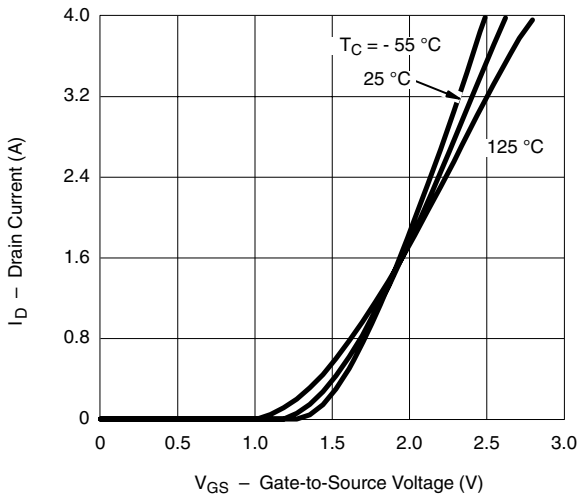
Notes:
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS T_A = 25 °C, unless noted

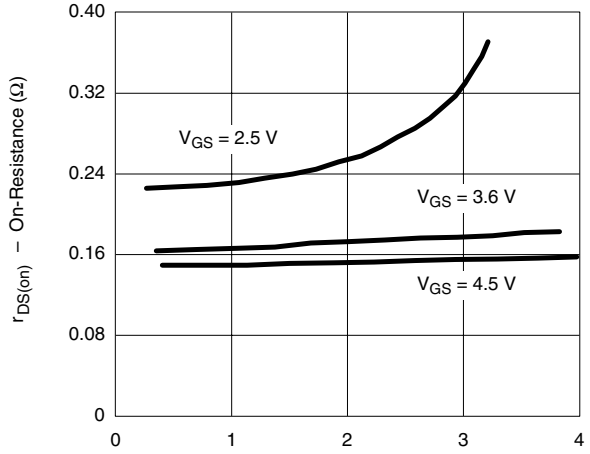


Output Characteristics

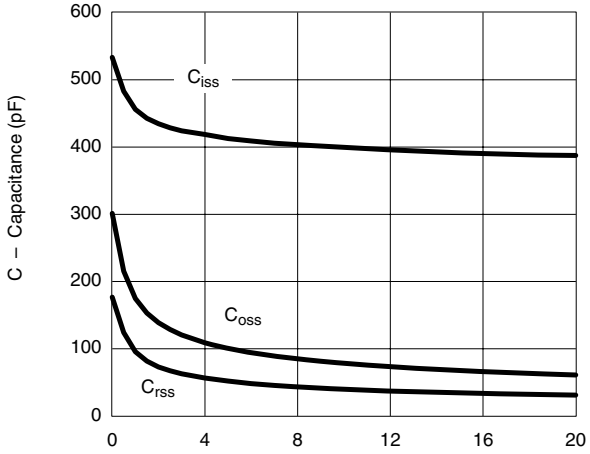


Transfer Characteristics

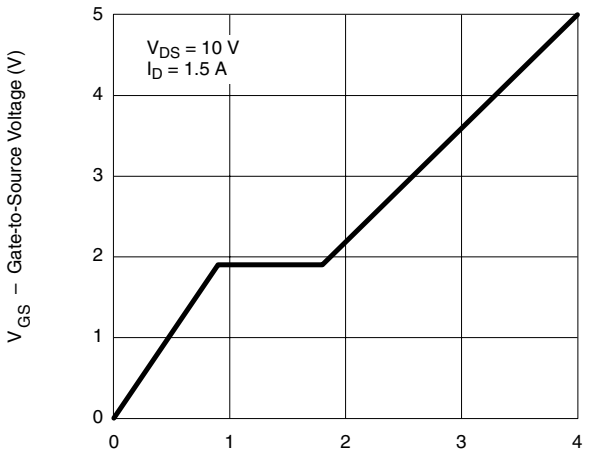
TYPICAL CHARACTERISTICS T_A = 25 °C, unless noted



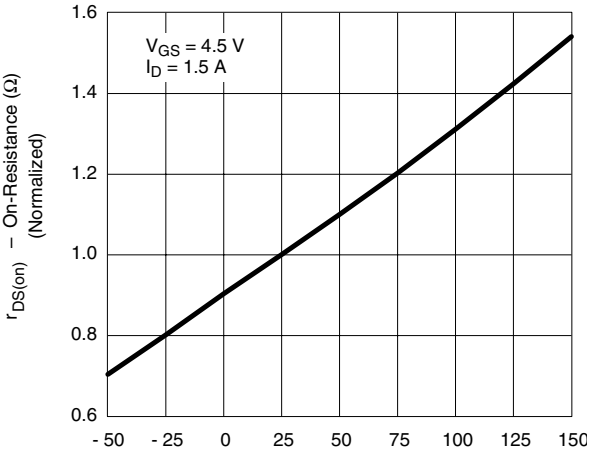
On-Resistance vs. Drain Current



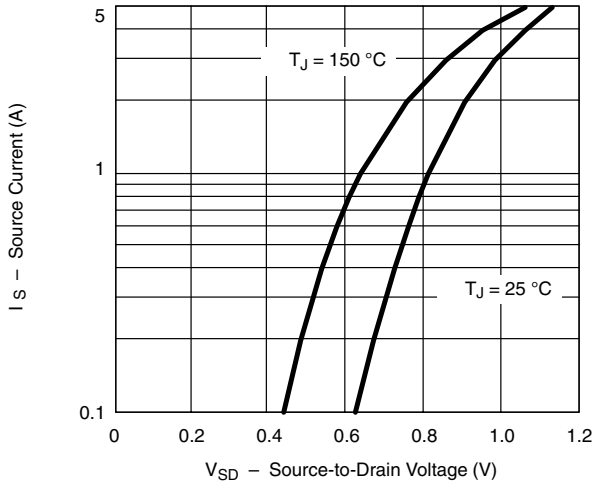
Capacitance



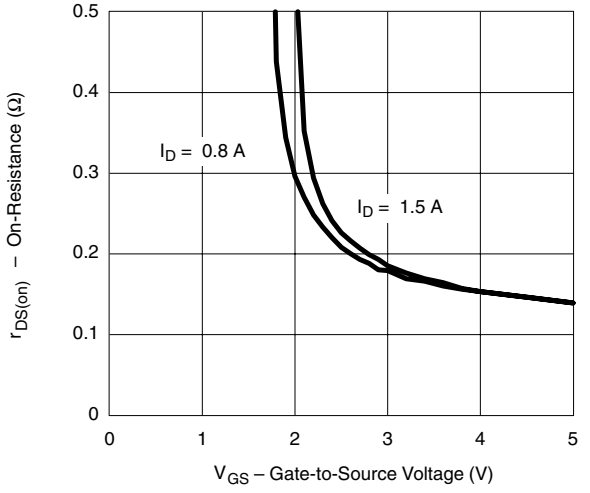
Gate Charge



On-Resistance vs. Junction Temperature

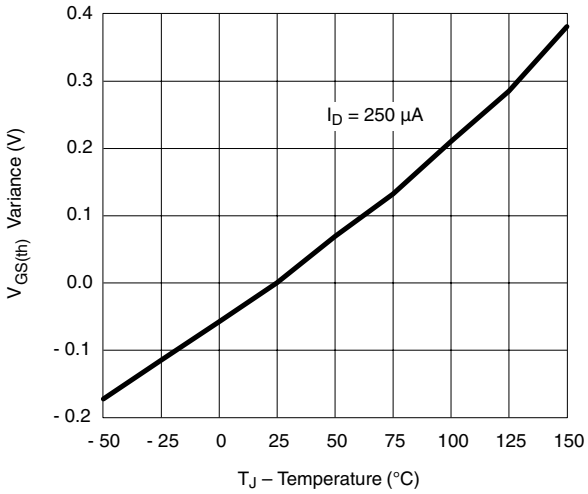


Capacitance

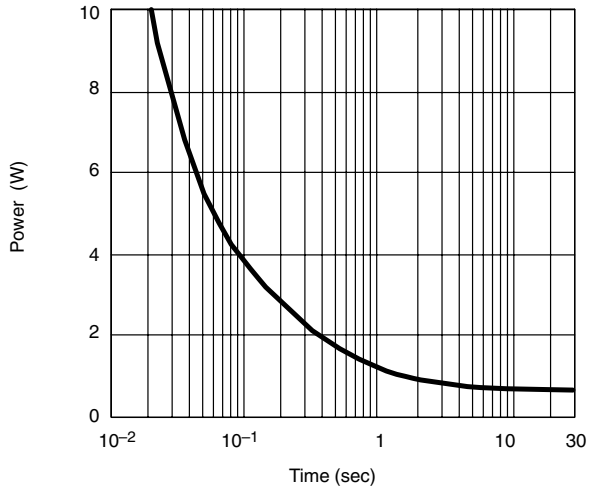


On-Resistance vs. Gate-to-Source Voltage

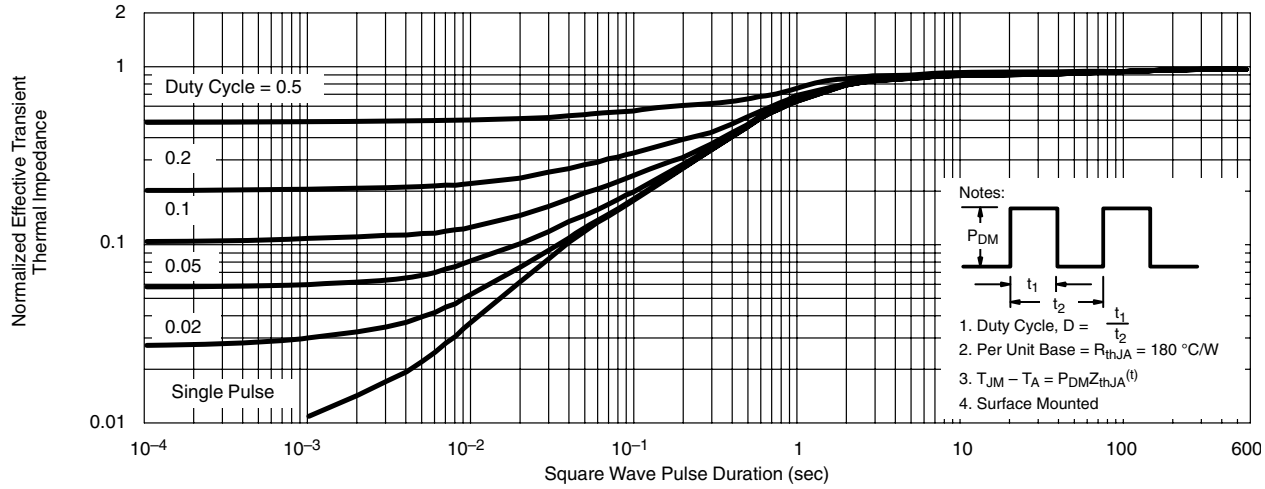
TYPICAL CHARACTERISTICS T_A = 25 °C, unless noted



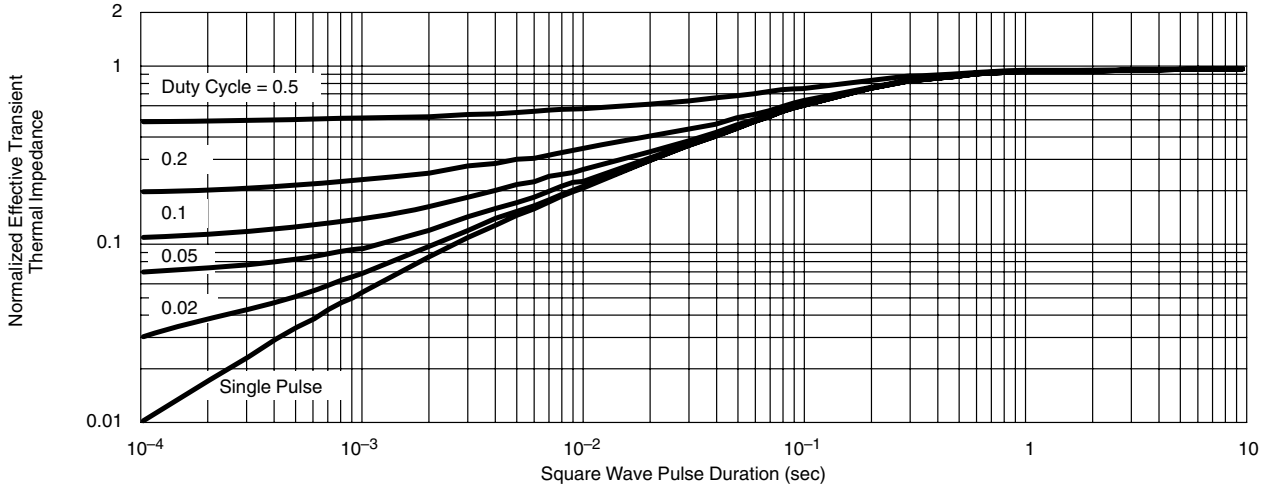
Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71072.

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, “Vishay”), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay’s terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay:

SI1403DL-T1-E3 SI1403DL-T1 SI1403DL-E3